

April 30, 2026

**Notice of the Holding of the Groundbreaking Ceremony for a New Factory of  
the Wafer Reclaim Business in Hefei, Anhui, China**

Ferrotec Corporation (Representative Director: He Xian Han; hereinafter “the Company”) announces that Ferrotec Yangtze (Hefei) Semiconductor Material Co., Ltd., a subsidiary engaged in the Wafer Reclaim Business, held a groundbreaking ceremony for its new factory in Hefei, Anhui Province, China on April 23, 2026.

**1. Outline of the new factory**

(1)	Location	Xinzhan, Hefei, Anhui Province, Peoples Republic of China
(2)	Factory area	Approx. 80,000 m <sup>2</sup>
(3)	Scheduled start of operation	December 2027

**2. Outline of the subsidiary as of March 31, 2026**

(1)	Name	Ferrotec Yangtze (Hefei) Semiconductor Material Co., Ltd.	
(2)	Address	Xinzhan, Hefei, Anhui Province, Peoples Republic of China	
(3)	Title and name of representative	He Xian Han, Representative Director	
(4)	Business	Wafer Reclaim Business, etc.	
(5)	Capital	1 billion yuan (approx. 23.4 billion yen) *1 Chinese yuan = 23.43 yen (Capital at the time of establishment: 100 million yuan (approx. 2.3 billion yen))	
(6)	Date of establishment	March 3, 2026	
(7)	Major shareholder and shareholding ratio	Anhui Changjiang Reclaim Semiconductor Material Co., Ltd. (CRSM): 100%	
(8)	Relationship between Ferrotec Yangtze and the Company	Capital relationship	Ferrotec Yangtze is a wholly owned subsidiary CRSM, which is a subsidiary of the Company.
		Personnel relationship	Representative Director of the Company concurrently serves as the Director of Ferrotec Yangtze.
		Business relationship	Not applicable

[For reference: Groundbreaking ceremony]



[For reference: Image of the new factory]

